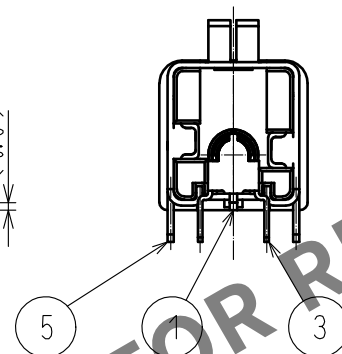
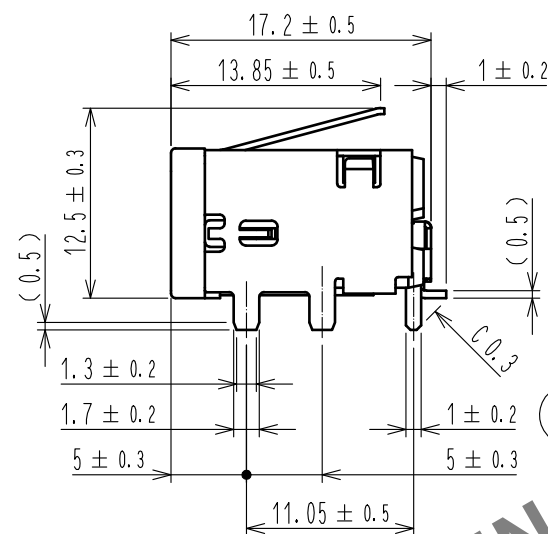
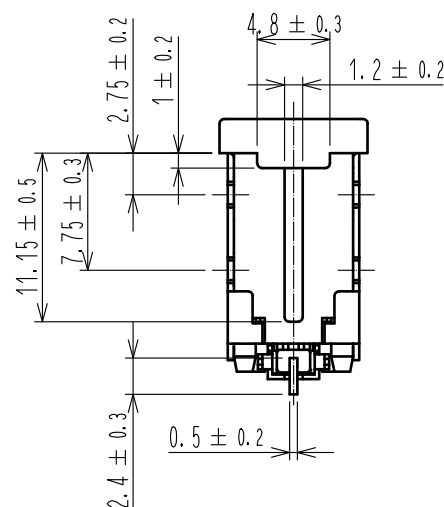
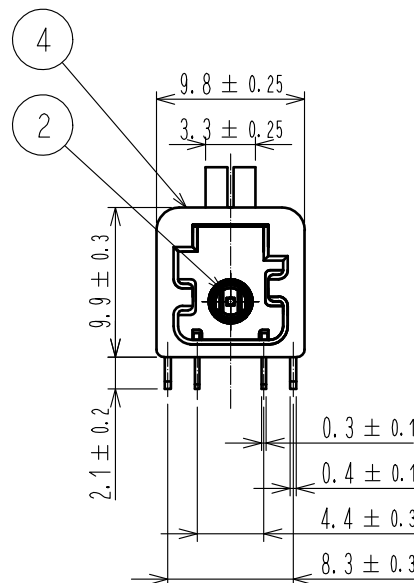
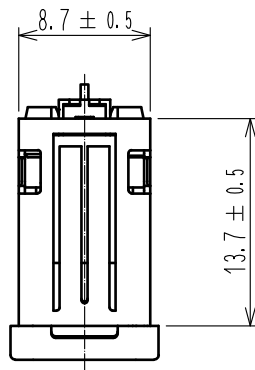
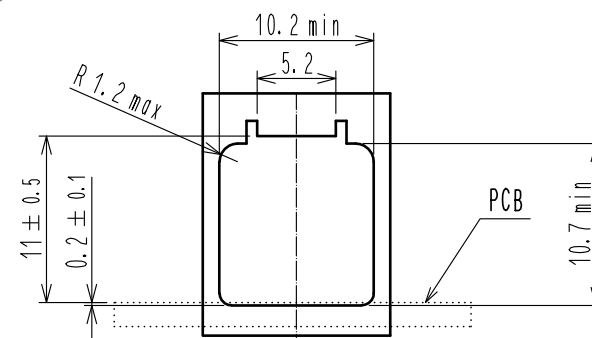


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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

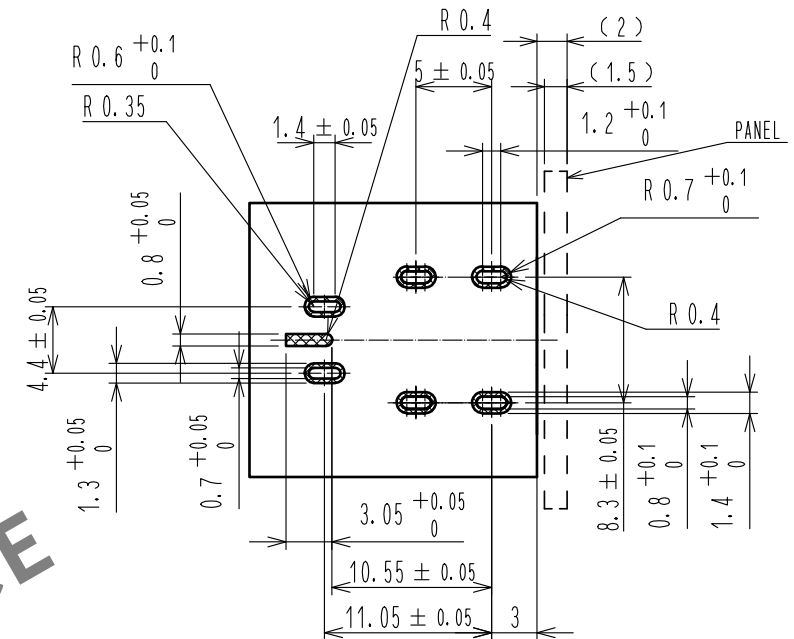
ELV. RoHS COMPLIANT



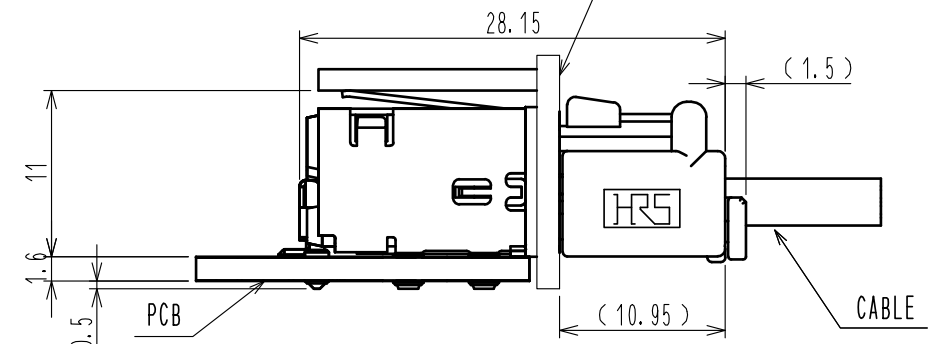
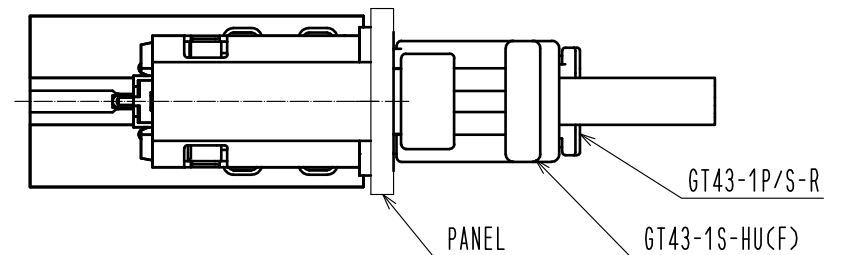
RECOMMENDED PANEL LAYOUT



RECOMMENDED PC BOARD PATTERN

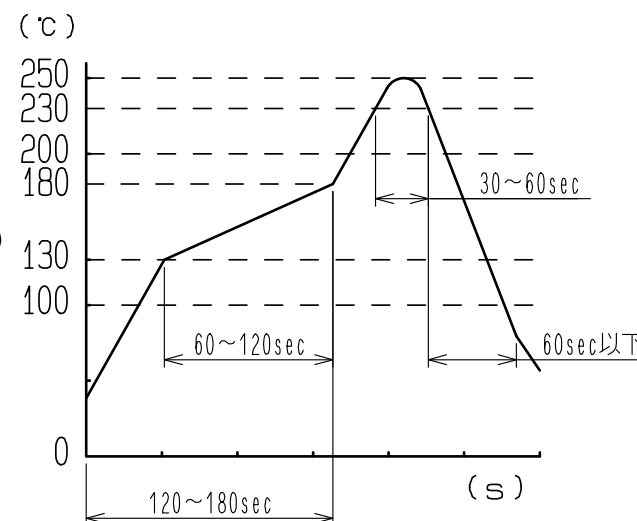


MATED CONNECTORS



NOTES

1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW (REFER TO RIGHT FIG.)
NO. OF CYCLES : 2
PEAK : 250°C
OVER 230°C : 30~60s
PREHEAT : 130~180°C, 60~120s
2. TEMPERATURE FOR SOLDERING IRON: 280~300°C WITHIN 2s
3. RECOMMENDED PCB THICKNESS : 1.6 ^{+0.2}/₀ mm
4. RECOMMENDED THICKNESS OF SOLDERING PASTE : 0.15mm



3	BRASS	TIN PLATING					
2	PA	BLACK	5	COPPER ALLOY Δ 1	TIN PLATING		
1	BRASS	TIN PLATING	4	PA	PURPLE		
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS		
UNITS mm		SCALE 2 : 1	COUNT Δ 1	DESCRIPTION OF REVISIONS DIS-T-00003144	DESIGNED NK. IKUTA	CHECKED KI. HIROKAWA	DATE 18.04.05
HIROSE ELECTRIC CO., LTD.		APPROVED : KI. HIROKAWA	18.03.24	DRAWING NO.	EDC-377155-00-00		
		CHECKED : KI. HIROKAWA	18.03.24	PART NO.	GT43D-1P-HCF)		
		DESIGNED : NK. IKUTA	18.03.24	CODE NO.	CL753-1018-0-00		
		DRAWN : DS. HIROWATARI	18.03.20		Δ 1/1		